NALOG Product/Process Change Notice - PCN 20_0367 Rev. -

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This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date. ADI contact information is listed below.

PCN Title:HMC8410/HMC8411 Data Sheet RevisionPublication Date:19-Feb-2021Effectivity Date:19-Feb-2021 (the earliest date that a customer could expect to receive changed material)

Revision Description: Initial Release.

Description Of Change:

HMC8410CHIPS Data Sheet Thermal Resistance - From: 75.57 C/W, To: 125.85 C/W. HMC8410LP2FE Data Sheet Thermal Resistance - From: 67.73 C/W, To: 128.92 C/W. HMC8411LP2FE Data Sheet Thermal Resistance - From: 82 C/W, To: 115.35 C/W. HMC8411TCPZ-EP Data Sheet Thermal Resistance - From: 82 C/W, To: 115.35 C/W. HMC8411LP2FE Data Sheet Thermal Resistance - From: 82 C/W, To: 115.35 C/W. HMC8411LP2FE Data Sheet Minimum P1dB Compression Over the 6 to 10 GHz Frequency Range: From: 14 dBm, To: 13dBm. HMC8411TCPZ-EP Data Sheet Minimum P1dB Compression Over the 6 to 10 GHz Frequency Range: From: 14 dBm, To: 13dBm.

Reason For Change:

HMC8410CHIPS/HMC8410LP2FE/HMC8411LP2FE/HMC8411TCPZ-EP Data Sheet Thermal Resistance - Updated thermal analysis to reflect more accurately the device performance.

HMC8411LP2FE/HMC8411TCPZ-EP Data Sheet Minimum P1dB Compression - Properly account for performance variations observed during Production Lot testing.

Impact of the change (positive or negative) on fit, form, function & reliability:

No change to device form, fit and reliability. Changes should be reviewed to determine if any system and/or documentation changes are required at the customer site.

Summary of Supporting Information:

HMC8410CHIPS New Product Data Sheet Thermal Resistance Rev C. HMC8410LP2FE New Product Data Sheet Thermal Resistance Rev D. HMC8411LP2FE New Product Data Sheet Thermal Resistance Rev C. HMC8411TCPZ-EP New Product Data Sheet Thermal Resistance & Minimum P1dB Compression from 6 GHz to 10 GHz Rev A. HMC8411LP2FE New Product Data Sheet Minimum P1dB Compression from 6 GHz to 10 GHz Rev A.

Supporting Documents

Attachment 1: Type: Datasheet Specification Comparison ADI_PCN_20_0367_Rev_-_HMC8410 Die Datasheet Update PCN.pdf

Attachment 2: Type: Datasheet Specification Comparison

ADI_PCN_20_0367_Rev_-_HMC8410LP2FE Datasheet Update PCN.pdf

Attachment 3: Type: Datasheet Specification Comparison ADI_PCN_20_0367_Rev_-_HMC8411LP2FE Datasheet Update PCN.pdf

Attachment 4: Type: Datasheet Specification Comparison ADI_PCN_20_0367_Rev_-_HMC8411TCPZ-EP Datasheet Update PCN.pdf

For questions on this PCN, p	contacts below or contact your loc	al ADI sales representatives.	
Americas:	Europe:	Japan:	Rest of Asia:
PCN_Americas@analog.com	PCN_Europe@analog.com	PCN_Japan@analog.com	PCN_ROA@analog.com

Appendix A - Affected ADI Models					
	Added Parts On This Revision - Product Family / Model Number (12)				
HMC8410/HMC8410CHIPS	HMC8410/HMC8410CHIPS-SX	HMC8410/HMC8410LP2FE	HMC8410/HMC8410LP2FETR	HMC8411 / AD45294	
HMC8411/AD45294TR	HMC8411/HMC8411LP2FE	HMC8411/HMC8411LP2FETR	HMC8411/HMC8411TCPZ-EP-PT	HMC8411/HMC8411TCPZ-EP-R7	
HMC8411/HMC8411XCHIP	HMC8411/HMC8411XP2FE				

Appendix B - Revision History					
Rev	Publish Date	Effectivity Date	Rev Description		
Rev	19-Feb-2021	19-Feb-2021	Initial Release.		

Analog Devices, Inc.

Docld:8376 Parent Docld:None Layout Rev:7